PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DONG WEI	10/15/2009

RECEIVING PARTY DATA

Name:	AMBIT MICROSYSTEMS (SHANGHAI) LTD.
Street Address:	NO.1925, NANLE ROAD,SONG JIANG EXPORT PROCESSING ZONE
City:	SHANGHAI
State/Country:	CHINA

Name:	HON HAI PRECISION INDUSTRY CO., LTD.	
Street Address:	66,CHUNG SHAN ROAD	
City:	Tu-Cheng,Taipei Hsien	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12581230

CORRESPONDENCE DATA

Fax Number: (909)978-6366

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 9099786584

Email: Raymond.Chew@foxconn.com

Correspondent Name: Raymond J. Chew
Address Line 1: 288 South Mayo Avenue

Address Line 4: City of Industry, CALIFORNIA 91789

ATTORNEY DOCKET NUMBER:	US17689
NAME OF SUBMITTER:	Raymond J. Chew

PATENT REEL: 023402 FRAME: 0076 \$40.00

500993775

Total Attachments: 2 source=US17689091016ASM#page1.tif source=US17689091016ASM#page2.tif

> PATENT REEL: 023402 FRAME: 0077

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1.	DONG WEI	, residing at	Shanghai, China
2.		, residing at	
3.		, residing at	
4.		, residing at	
5.		, residing at	
6.		, residing at	
7.		, residing at	
8.		, residing at	,
having a	principal place of b	ousiness at NO.1925, NGHAI 201613, P.R.	BIT MICROSYSTEMS (SHANGHAI) LT NANLE ROAD, SONG JIANG EXPOR C. and HON HAI PRECISION INDUSTR
			6,Chung Shan Road, Tu-Cheng City, Taip
Hsien, T	aiwan, R.O.C. hereaf	ter designated "ASSIC	SNEE" the entire right, title and interest for the
United S	tates of America as d	efined in 35 U.S.C. 1	00, in the invention and all patent application
including	any and all division	ns, continuations, subs	stitutes, and reissues thereof, and all resulting

previously executed --- Ser. No. _____ and filing date of ____ | x | is executing concurrently herewith

an application for Letters Patent of United States of America

THE SAME for which the undersigned

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

patents, known as ACCESSORY PCB FIXTURE AND ELECTRONIC DEVICE EMPLOYING

AND the undersigned hereby agrec(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

> PATENT REEL: 023402 FRAME: 0078

Oct. 15, 2009		9
DONG WEI	Date	Witness
	Date	Witness